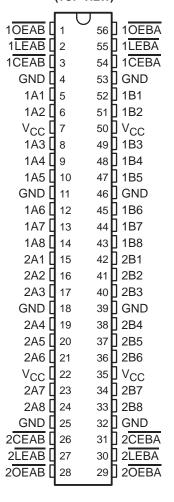
- **Members of the Texas Instruments** Widebus™ Family
- Inputs Are TTL-Voltage Compatible
- **3-State True Outputs**
- Flow-Through Architecture Optimizes PCB Layout
- Distributed V_{CC} and GND Pin **Configurations Minimize High-Speed Switching Noise**
- **EPIC** [™] (Enhanced-Performance Implanted CMOS) 1-um Process
- 500-mA Typical Latch-Up Immunity at
- **Package Options Include Plastic Thin** Shrink Small-Outline (DGG) and 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings, and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center **Pin Spacings**

description

The 'ACT16543 are 16-bit registered transceivers that contain two sets of D-type latches for temporary storage of data flowing in either direction. The 'ACT16543 can be used as two 8-bit transceivers or one 16-bit transceiver. Separate latch enable (LEAB or LEBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (CEAB) and OEAB inputs must be low to enter data from A or to output data to B. Having CEAB low and LEAB low makes the A-to-B latches transparent; a subsequent low-tohigh transition at LEAB puts the A latches in the storage mode. Data flow from B to A is similar, but requires using the CEBA, LEBA, and OEBA inputs.

54ACT16543...WD PACKAGE 74ACT16543 . . . DGG OR DL PACKAGE (TOP VIEW)



The 74ACT16543 is packaged in TI's shrink small-outline package, which provides twice the functionality of standard small-outline packages in the same printed-circuit-board area.

The 54ACT16543 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74ACT16543 is characterized for operation from -40°C to 85°C.



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54ACT16543, 74ACT16543 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS126B - MARCH 1990 - REVISED APRIL 1996

FUNCTION TABLE (each octal register)

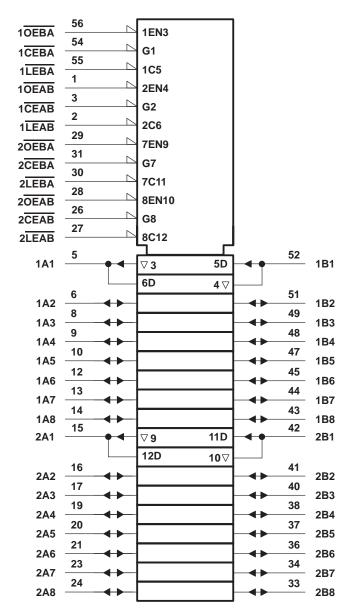
	INPUTS		LATCH STATUS	OUTPUT BUFFERS
CEAB	LEAB	OEAB	A TO BT	BUFFERS B1-B8
Н	Х	Х	Storing	Z
Х	Н	Χ	Storing	
Х	Χ	Н		Z
L	L	L	Transparent	Current A data
L	Н	L	Storing	Previous A data [‡]

[†] A-to-B data flow is shown: B-to-A flow control is the same except that it uses CEBA, LEBA, and OEBA.



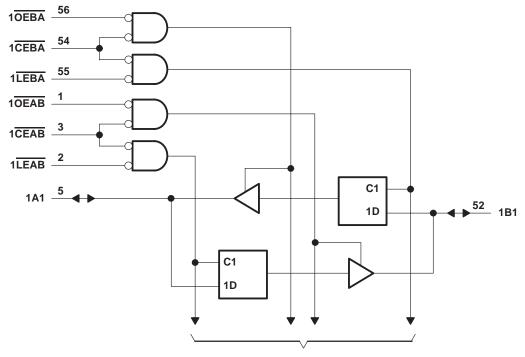
[‡] Data present before low-to-high transition of LEAB occurring while CEAB is low

logic symbol†

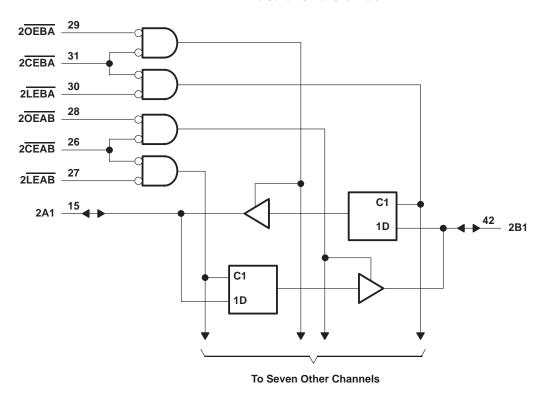


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



To Seven Other Channels





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	
Output voltage range, VO (see Note 1)	
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V _{CC} or GND	±400 mA
Maximum power dissipation at $T_A = 55^{\circ}$ C (in still air) (see Note 2): D	GG package 1 W
D	L package 1.4 W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		54.	ACT165	43	74ACT16543			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage (see Note 4)	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2		7	2			V
V _{IL}	Low-level input voltage		Ś	0.8			0.8	V
٧ _I	Input voltage	0	27	VCC	0		VCC	V
Vo	Output voltage	0	1	VCC	0		VCC	V
ІОН	High-level output current		2	-24			-24	mA
loL	Low-level output current	0	5	24			24	mA
Δt/Δν	Input transition rise or fall rate	0		10	0		10	ns/V
TA	Operating free-air temperature	-55		125	-40		85	°C

NOTES: 3. Unused pins (inputs and I/O) must be held high or low to prevent them from floating.

4. All V_{CC} and GND pins must be connected to the proper voltage power supply.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

54ACT16543, 74ACT16543 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

SCAS126B - MARCH 1990 - REVISED APRIL 1996

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAI	RAMETER	TEST CONDITIONS	Vaa	T,	Վ = 25°C		54ACT	16543	74ACT	16543	UNIT
FAI	KAMETEK	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
		ΙΟΗ = -50 μΑ	4.5 V	4.4			4.4		4.4		
		ΙΟΗ = -50 μΑ	5.5 V	5.4			5.4		5.4		
Voн		1011 - 24 mA	4.5 V	3.94			3.8		3.8		V
		$I_{OH} = -24 \text{ mA}$	5.5 V	4.94			4.8		4.8		
		I _{OH} = -75 mA [†]	5.5 V				3.85	N.	3.85		
		lo 50 uA				0.1		0.1		0.1	
		ΙΟL = 50 μΑ	5.5 V			0.1		0.1		0.1	V
VOL		Jan. 24 mA	4.5 V			0.36	, C	0.44		0.44	
		I _{OL} = 24 mA	5.5 V			0.36	20	0.44		0.44	
		$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V) 	1.65		1.65	
IĮ	Control inputs	V _I = V _{CC} or GND	5.5 V			±0.1	7	±1		±1	μΑ
loz	A or B ports [‡]	$V_O = V_{CC}$ or GND	5.5 V			±0.5		±5		±5	μΑ
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80		80	μА
Δl _{CC} §		One input at 3.4 V, Other inputs at GND or V _{CC}	5.5 V			0.9		1		1	mA
Ci	Control inputs	V _I = V _{CC} or GND	5 V		4.5						pF
C _{io}	A or B ports	$V_O = V_{CC}$ or GND	5 V		12						PΓ

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		$T_A = 2$	25°C	54ACT	16543	74ACT16543		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	ONIT
t _W	Pulse duration, LEAB or LEBA low	7.5		7.5	S'M	7.5		ns
t _{su}	Setup time, data before LEAB or LEBA↑	2.5		2.5	lle.	2.5		ns
t _h	Hold time, data after LEAB or LEBA↑	4		4		4		ns



[‡] For I/O ports, the parameter IOZ includes the input leakage current.

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.

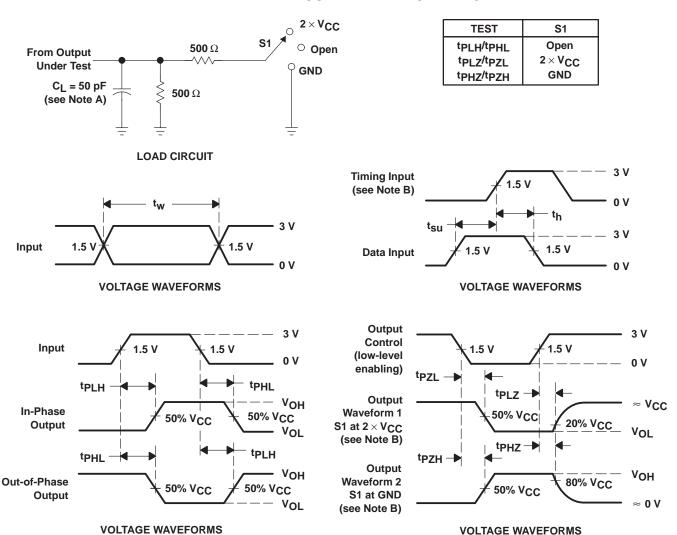
switching characteristics over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T,	λ = 25°C	;	54ACT	16543	74ACT	16543	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	ONII
t _{PLH}	A or B	B or A	3.5	6.9	9.5	3.5	10.5	3.5	10.5	ns
tPHL	AOIB	BOIA	3.1	7.3	10.7	3.1	11.6	3.1	11.6	115
^t PLH		A or B	3.9	8.6	12.3	3.9	13.8	3.9	13.8	ns
t _{PHL}	LEBA or LEAB	AUIB	3.9	8.7	12.2	3.9	13.5	3.9	13.5	115
^t PZH	OEBA or OEAB	A or B	2.6	7.1	10.3	2.6	11.4	2.6	11.4	ns
tPZL	OEBA OF OEAB	AUIB	3.5	8.3	11.9	3.5	13.2	3.5	13.2	115
t _{PHZ}	OEBA or OEAB	A or B	4.1	8.2	10.5	4.1	11.1	4.1	11.1	ns
t _{PLZ}	OEBA OI OEAB	AOIB	5	7.3	9.3	0 5	9.6	5	9.6	115
^t PZH	CEBA or CEAB	A or B	3.1	7.3	10.7	3.1	11.7	3.1	11.7	no
t _{PZL}	CEBA OF CEAB	AUIB	3.9	8.5	12.2	3.9	13.5	3.9	13.5	ns
^t PHZ	CEBA or CEAB	A or B	4.6	8.5	11	4.6	11.6	4.6	11.6	20
t _{PLZ}	CEDA OF CEAB	AUID	5.2	7.4	9.7	5.2	10.5	5.2	10.5	ns

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CO	TYP	UNIT		
	Dower discinction conscitance per transceiver	Outputs enabled	C ₁ = 50 pF,	f = 1 MHz	45	pF
Cpd	Power dissipation capacitance per transceiver	Outputs disabled	CL = 50 pr,	I = I IVINZ	12	

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f = 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
74ACT16543DGGR	Active	Production	TSSOP (DGG) 56	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT16543
74ACT16543DGGR.A	Active	Production	TSSOP (DGG) 56	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT16543
74ACT16543DL	Obsolete	Production	SSOP (DL) 56	-	-	Call TI	Call TI	-40 to 85	ACT16543
74ACT16543DLR	Active	Production	SSOP (DL) 56	1000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT16543
74ACT16543DLR.A	Active	Production	SSOP (DL) 56	1000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT16543

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

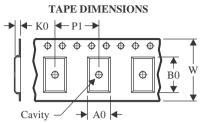
⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

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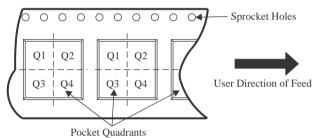
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
74ACT16543DGGR	TSSOP	DGG	56	2000	330.0	24.4	8.9	14.7	1.4	12.0	24.0	Q1
74ACT16543DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
74ACT16543DGGR	TSSOP	DGG	56	2000	356.0	356.0	45.0
74ACT16543DLR	SSOP	DL	56	1000	356.0	356.0	53.0

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